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silicon, copper, aluminum or alloys thereof, and wherein the cured adhesive bonds at least two of the substrates to one another.

45. (New) The radiation-curable adhesive composition according to claim 1, wherein the radiation-curable adhesive composition further comprises dicyclopentyldimethylene diacrylate.

- 46. (New) Optical media according to claim 20, wherein the radiation-curable composition further comprises dicyclopentyldimethylene diacrylate.
- 47. (New) The optical media according to claim 46, further comprising at least two substrates, wherein the reflective or semi-reflective layer comprises silver, aluminum or alloys thereof.
- 48. (New) The radiation-curable optical disc composition according to claim 32, wherein the composition further comprises dicyclopentyldimethylene diacrylate.
- 49. (New) Optical media/comprising the cured radiation-curable composition set forth in claim 48.